



## **General Description**

The AOZ8906 is a transient voltage suppressor array designed to protect high speed data lines such as HDMI, USB 2.0, MDDI, SATA, and Gigabit Ethernet from damaging ESD events.

This device incorporates eight surge rated, low capacitance steering diodes and a TVS in a single package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground.

The AOZ8906 provides a typical line to line capacitance of 1pF making it ideally suited for HDMI 1.3 or USB 2.0 applications, such as Digital TVs, DVD players, Computing, set-top boxes and MDDI

The AOZ8906 comes in RoHS compliant and halogen free SOT23-6L package and is rated -40°C to +85°C junction temperature range.

applications in mobile computing devices.

#### **Features**

- ESD protection for high-speed data lines:
  - IEC 61000-4-2, level 4 (ESD) immunity test
  - ±30kV (air discharge) and ±30kV (contact discharge)
  - IEC61000-4-4 (EFT) 40A (5/50nS)
  - IEC61000-4-5 (Lightning) 7A (8/20µS)
  - Human Body Model (HBM) ±30kV
- Array of surge rated diodes with internal TVS diode
- Protects four I/O lines
- Low capacitance between I/O lines: 1pF
- Low clamping voltage
- Low operating voltage: 5.0V

## **Applications**

- HDMI, USB 2.0, MDDI, SATA ports
- Monitors and flat panel displays
- Set-top box
- Video graphics cards
- Notebook computers



# **Typical Application**

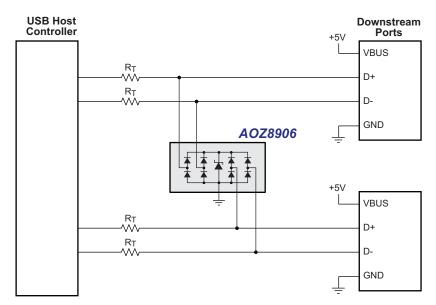


Figure 1. USB High Speed Ports



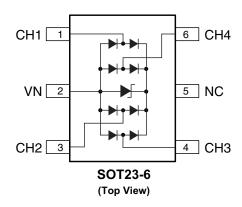
# **Ordering Information**

Part Number	Ambient Temperature Range	Package	Environmental
AOZ8906CI	-40°C to +85°C	SOT23-6L	RoHS Compliant Green Product



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

# **Pin Configuration**



## **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Storage Temperature (T <sub>S</sub> )	-65°C to +150°C
ESD Rating per IEC61000-4-2, contact <sup>(1)</sup>	±30kV
ESD Rating per IEC61000-4-2, air <sup>(1)</sup>	±30kV
ESD Rating per Human Body Model <sup>(2)</sup>	±30kV

#### Notes

- 1. IEC 61000-4-2 discharge with C  $_{\rm Discharge}$  = 150pF, R  $_{\rm Discharge}$  = 330 $\Omega.$
- 2. Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge}$  = 100pF,  $R_{Discharge}$  = 1.5k $\Omega$ .

# **Maximum Operating Ratings**

	Parameter	Rating	
,	Junction Temperature (T <sub>J</sub> )	-40°C to +125°C	

Rev. 2.0 December 2015 **www.aosmd.com** Page 2 of 7



# **Electrical Characteristics**

 $T_A = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Тур.	Max.	Units
$V_{RWM}$	Reverse Working Voltage	Between I/O and VN <sup>(3)</sup>			5.5	V
$V_{BR}$	Reverse Breakdown Voltage	I <sub>T</sub> = 100μA, between I/O and VN <sup>(4)</sup>				V
I <sub>R</sub>	Reverse Leakage Current	V <sub>RWM</sub> = 5V, between I/O and VN			1.0	μA
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> = 15mA		0.85	1.0	V
	Channel Clamp Voltage Positive Transients Negative Transients	I <sub>PP</sub> = 16A, tp = 100ns, any I/O pin to Ground <sup>(5)</sup>			4.1 -5.3	V
V <sub>CL</sub>	Channel Clamp Voltage Positive Transients Negative Transients	I <sub>PP</sub> = 30A, tp = 100ns, any I/O pin to Ground <sup>(5)</sup>			5.2 -9.9	V
	Channel Clamp Voltage Any I/O Pin to Ground	I <sub>PP</sub> = 7A, tp = 8/20μs			8	V
(	Channel Input Capacitance	V <sub>R</sub> = 0V, f = 1MHz, any I/O pin to Ground		1.0	1.5	pF
C <sub>j</sub>		V <sub>R</sub> = 0V, f = 1MHz, between I/O pins		0.5	0.8	pF
D	Dynamic Resistance	I <sub>TLP</sub> = 16A to 30A		0.15		Ω
$R_{DYN}$		I <sub>TLP</sub> = -16A to -30A		0.3		Ω

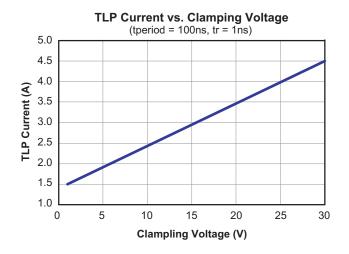
### Notes:

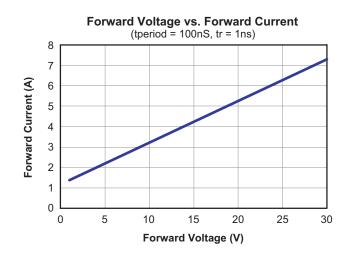
- $3. \ The \ working \ peak \ reverse \ voltage, \ V_{RWM}, \ should \ be \ equal \ to \ or \ greater \ than \ the \ DC \ or \ continuous \ peak \ operating \ voltage \ level.$
- 4.  $V_{BR}$  is measured at the pulse test current  $I_{T}$ .
- 5. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

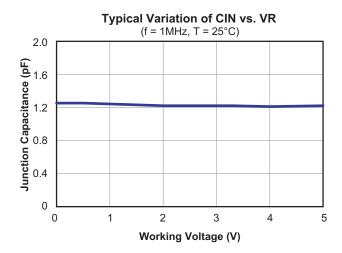
Rev. 2.0 December 2015 **www.aosmd.com** Page 3 of 7

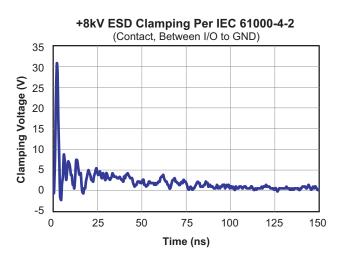


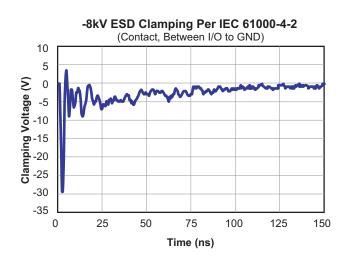
# **Typical Performance Characteristics**





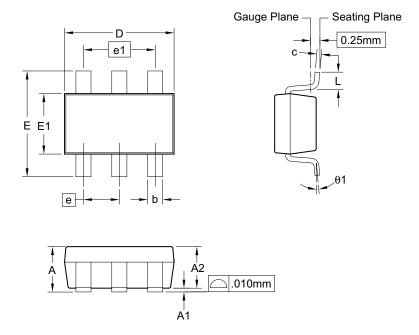




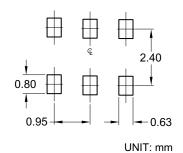




# Package Dimensions, SOT23-6L



### RECOMMENDED LAND PATTERN



### **Dimensions in millimeters**

Symbols	Min.	Nom.	Max.	
Α	0.90	_	1.25	
A1	0.00	_	0.15	
A2	0.80	1.10	1.20	
b	0.30	0.40	0.50	
С	0.08	0.13	0.20	
D	2.70	2.90	3.10	
E	2.50	2.80	3.10	
E1	1.50	1.60	1.70	
е	0.95 BSC			
e1	1.90 BSC			
L	0.30	_	0.60	
θ1	0°	_	8°	

### **Dimensions in inches**

Symbols	Min.	Nom.	Max.	
Α	0.035	_	0.049	
A1	0.00	_	0.006	
A2	0.031	0.043	0.047	
b	0.012	0.016	0.020	
С	0.003	0.005	0.008	
D	0.106	0.114	0.122	
E	0.098	0.110	0.122	
E1	0.059	0.063	0.067	
е	0.037 BSC			
e1	0.075 BSC			
L	0.012	_	0.024	
θ1	0°	_	8°	

### Notes:

- 1. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils each.
- 2. Dimension "L" is measured in gauge plane.
- 3. Tolerance  $\pm 0.100 mm$  (4 mil) unless otherwise specified.
- 4. Followed from JEDEC MO-178C & MO-193C.
- 6. Controlling dimension is millimeter. Converted inch dimensions are not necessarily exact.



SOT-23

3.15

±0.10

3.20

±0.10

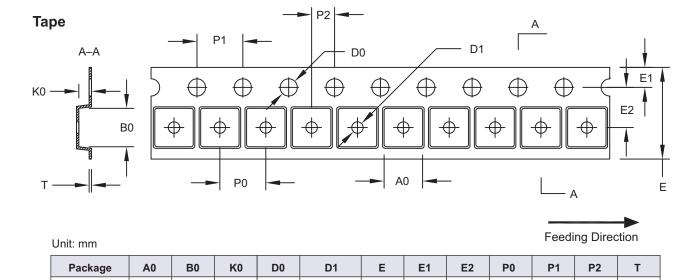
1.40

±0.10

1.50

±0.05

# Tape and Reel Dimensions, SOT23-6L



1.00

±0.10/-0.0

8.00

±0.30

1.75

±0.10

3.50

±0.05

4.00

±0.10

4.00

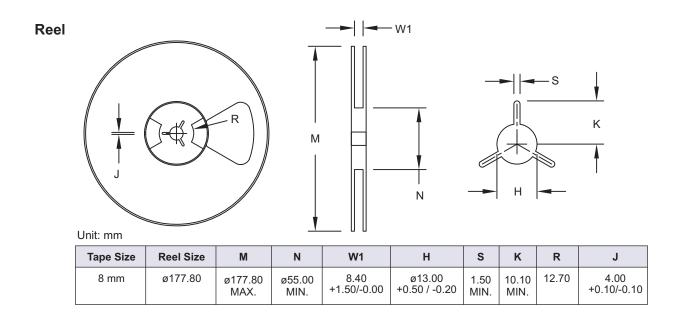
±0.10

2.00

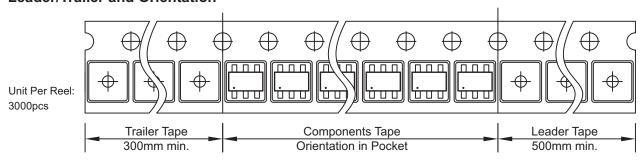
±0.05

0.23

±0.03

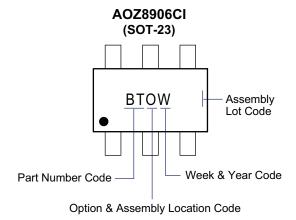


### Leader/Trailer and Orientation





## **Package Marking**



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